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CD4017B, CD4022B Types

CMOS Counter/Dividers

High-Voltage Types (20-Volt Rating)

CD4017B—Decade Counter with
10 Decoded Outputs

CD4022B—Octal Counter with
8 Decoded Outputs

■ CD4017B and CD4022B are 5-stage and 4-stage Johnson counters having 10 and 8 decoded outputs, respectively. Inputs include a CLOCK, a RESET, and a CLOCK INHIBIT signal. Schmitt trigger action in the CLOCK input circuit provides pulse shaping that allows unlimited clock input pulse rise and fall times.

These counters are advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. A high RESET signal clears the counter to its zero count. Use of the Johnson counter configuration permits high-speed operation, 2-input decode-gating and spike-free decoded outputs. Anti-lock gating is provided, thus assuring proper counting sequence. The decoded outputs are normally low and go high only at their respective decoded time slot. Each decoded output remains high for one full clock cycle. A CARRY-OUT signal completes one cycle every 10 clock input cycles in the CD4017B or every 8 clock input cycles in the CD4022B and is used to

Features:

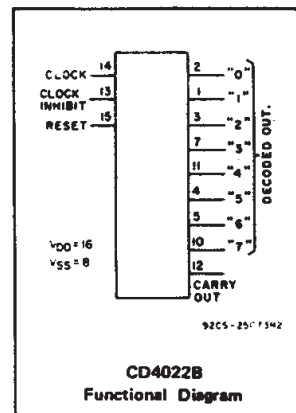
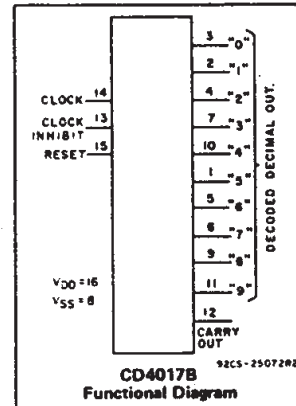
- Fully static operation
- Medium-speed operation . . . 10 MHz (typ.) at $V_{DD} = 10\text{ V}$
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Decade counter/decimal decode display (CD4017B)
- Binary counter/decoder
- Frequency division
- Counter control/timers
- Divide-by-N counting
- For further application information, see ICAN-6166 "COS/MOS MSI Counter and Register Design and Applications"

ripple-clock the succeeding device in a multi-device counting chain.

The CD4017B and CD4022B-series types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic package (E suffix), 16-lead ceramic flat packages (K suffix), and in chip form (H suffix).



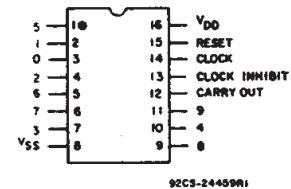
RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

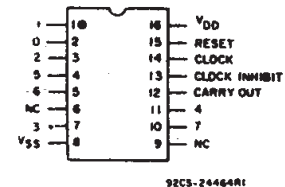
| CHARACTERISTICS | V_{DD} (V) | LIMITS | | UNITS |
|---|-----------------|------------|------|-------|
| | | Min. | Max. | |
| Supply-Voltage Range (For T_A = Full Package-Temperature Range) | | 3 | 18 | V |
| Clock Input Frequency, f_{CL} | 5 | — | 2.5 | MHz |
| | 10 | — | 5 | |
| | 15 | — | 5.5 | |
| Clock Pulse Width, t_W | 5 | 200 | — | ns |
| | 10 | 90 | — | |
| | 15 | 60 | — | |
| Clock Rise & Fall Time, t_{rCL} , t_{fCL} | 5 | UNLIMITED* | | |
| | 10 | | | |
| | 15 | | | |
| Clock Inhibit Setup Time, t_s | 5 | 230 | — | ns |
| | 10 | 100 | — | |
| | 15 | 70 | — | |
| Reset Pulse Width, t_{RW} | 5 | 260 | — | ns |
| | 10 | 110 | — | |
| | 15 | 60 | — | |
| Reset Removal Time, t_{rem} | 5 | 400 | — | ns |
| | 10 | 280 | — | |
| | 15 | 150 | — | |

*Only if Pin 14 is used as the clock input. If Pin 13 is used as the clock input and Pin 14 is tied high (for advancing count on negative transition of the clock), rise and fall time should be $\leq 15\ \mu\text{s}$.

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COMMERCIAL CMOS
HIGH VOLTAGE ICs

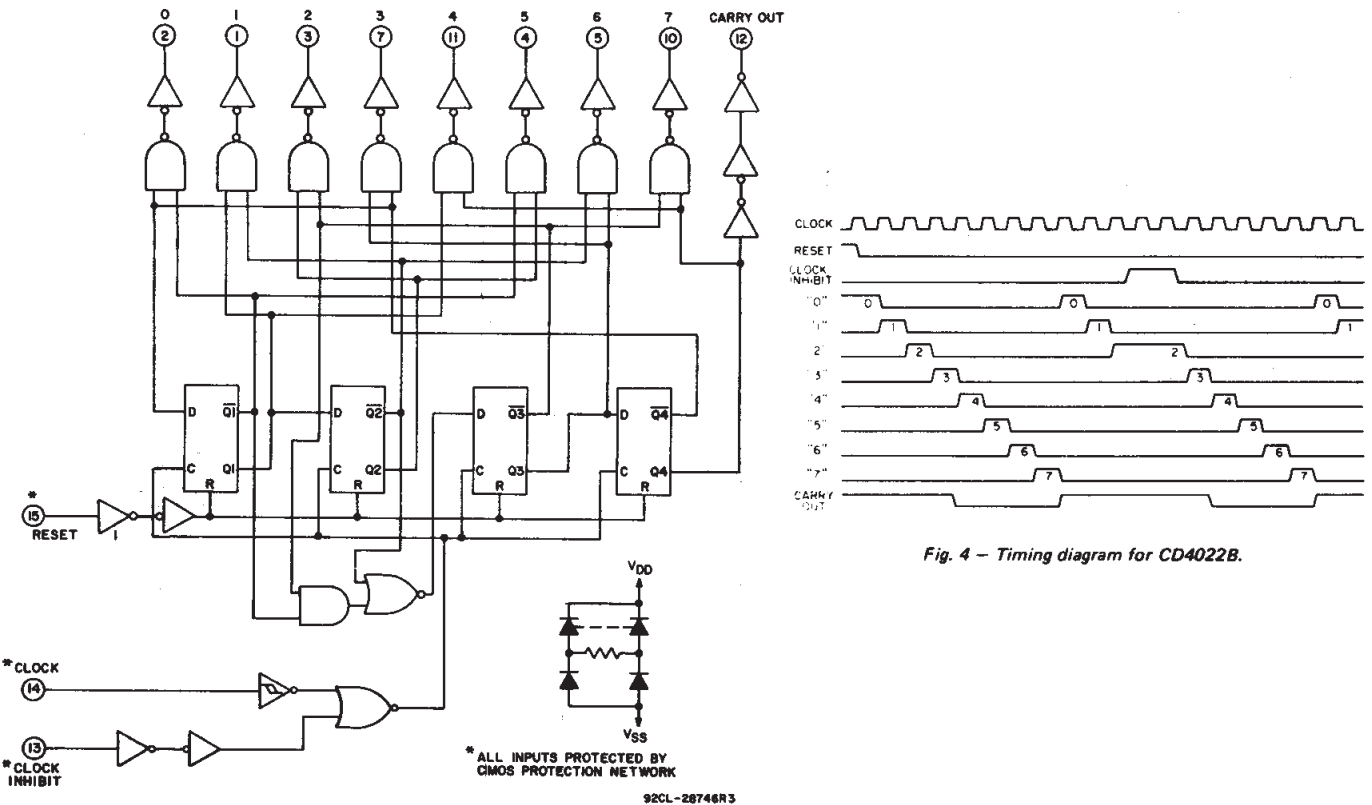
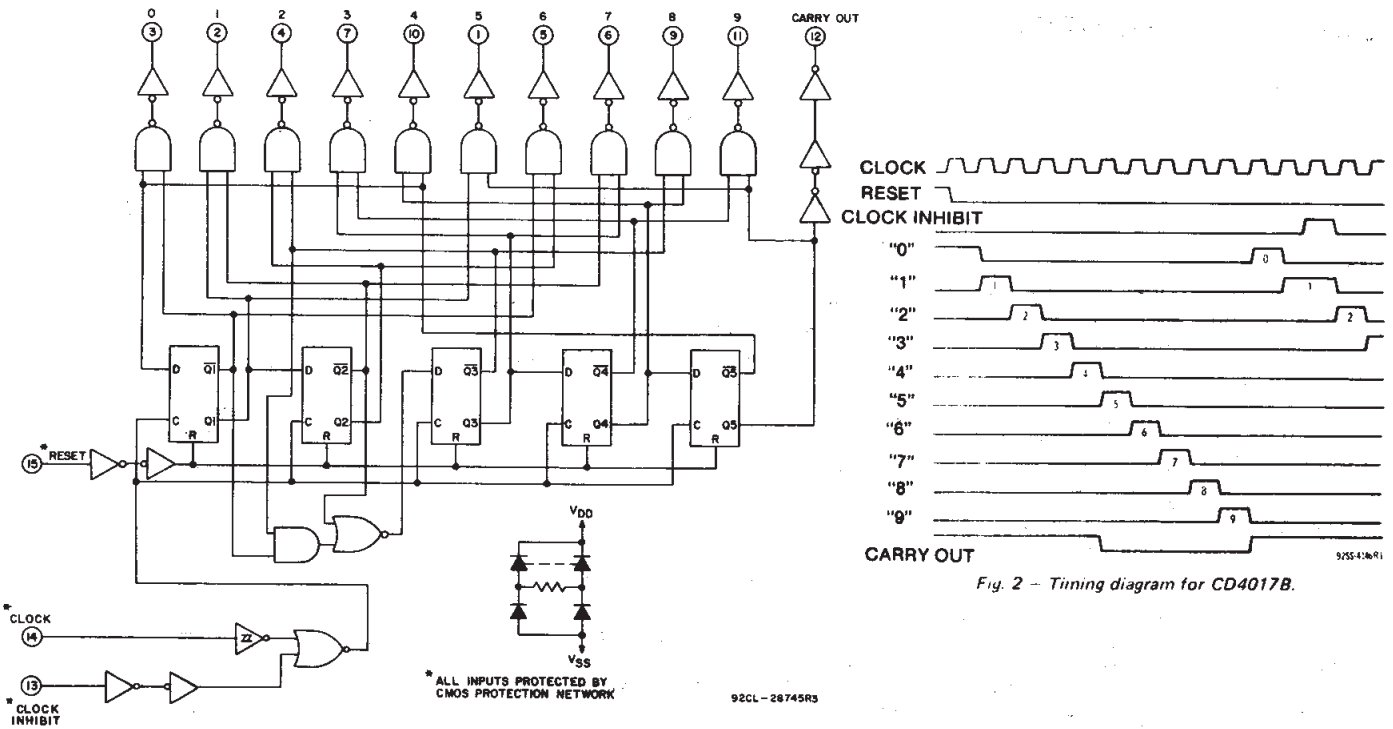


TOP VIEW
CD4017B
TERMINAL DIAGRAM



TOP VIEW
NC - no connection
CD4022B
TERMINAL DIAGRAM

CD4017B, CD4022B Types



CD4017B, CD4022B Types

MAXIMUM RATINGS, Absolute-Maximum Values:

| | |
|--|---|
| DC SUPPLY-VOLTAGE RANGE, (V_{DD}) | -0.5V to +20V |
| Voltages referenced to V_{SS} Terminal) | |
| INPUT VOLTAGE RANGE, ALL INPUTS | -0.5V to $V_{DD} + 0.5V$ |
| DC INPUT CURRENT, ANY ONE INPUT | $\pm 10mA$ |
| POWER DISSIPATION PER PACKAGE (P_D): | |
| For $T_A = -55^\circ C$ to $+100^\circ C$ | 500mW |
| For $T_A = +100^\circ C$ to $+125^\circ C$ | Derate Linearly at $12mW/^\circ C$ to 200mW |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR | |
| FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Types) | 100mW |
| OPERATING-TEMPERATURE RANGE (T_A) | $-55^\circ C$ to $+125^\circ C$ |
| STORAGE TEMPERATURE RANGE (T_{stg}) | $-65^\circ C$ to $+150^\circ C$ |
| LEAD TEMPERATURE (DURING SOLDERING): | |
| At distance $1/16 \pm 1/32$ inch ($1.59 \pm 0.79mm$) from case for 10s max | $+265^\circ C$ |

STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC | CONDITIONS | | | LIMITS AT INDICATED TEMPERATURES ($^\circ C$) | | | | | | | UNITS |
|---|--------------|-----------------|-----------------|---|-----------|---------|---------|-------|---------------|-----------|---------|
| | V_O (V) | V_{IN} (V) | V_{DD} (V) | -55 | -40 | +85 | +125 | +25 | | | |
| | | | | | | | | Min. | Typ. | Max. | |
| Quiescent Device Current, I_{DD} Max. | - | 0.5 | 5 | 5 | 5 | 150 | 150 | - | 0.04 | 5 | μA |
| | - | 0.10 | 10 | 10 | 10 | 300 | 300 | - | 0.04 | 10 | |
| | - | 0.15 | 15 | 20 | 20 | 600 | 600 | - | 0.04 | 20 | |
| | - | 0.20 | 20 | 100 | 100 | 3000 | 3000 | - | 0.08 | 100 | |
| Output Low (Sink) Current I_{OL} Min. | 0.4 | 0.5 | 5 | 0.64 | 0.61 | 0.42 | 0.36 | 0.51 | 1 | - | mA |
| | 0.5 | 0.10 | 10 | 1.6 | 1.5 | 1.1 | 0.9 | 1.3 | 2.6 | - | |
| | 1.5 | 0.15 | 15 | 4.2 | 4 | 2.8 | 2.4 | 3.4 | 6.8 | - | |
| Output High (Source) Current, I_{OH} Min. | 4.6 | 0.5 | 5 | -0.64 | -0.61 | -0.42 | -0.36 | -0.51 | -1 | - | mA |
| | 2.5 | 0.5 | 5 | -2 | -1.8 | -1.3 | -1.15 | -1.6 | -3.2 | - | |
| | 9.5 | 0.10 | 10 | -1.6 | -1.5 | -1.1 | -0.9 | -1.3 | -2.6 | - | |
| | 13.5 | 0.15 | 15 | -4.2 | -4 | -2.8 | -2.4 | -3.4 | -6.8 | - | |
| Output Voltage: Low-Level, V_{OL} Max. | - | 0.5 | 5 | 0.05 | | | | - | 0 | 0.05 | V |
| | - | 0.10 | 10 | 0.05 | | | | - | 0 | 0.05 | |
| | - | 0.15 | 15 | 0.05 | | | | - | 0 | 0.05 | |
| Output Voltage: High-Level, V_{OH} Min. | - | 0.5 | 5 | 4.95 | | | | 4.95 | 5 | - | V |
| | - | 0.10 | 10 | 9.95 | | | | 9.95 | 10 | - | |
| | - | 0.15 | 15 | 14.95 | | | | 14.95 | 15 | - | |
| Input Low Voltage V_{IL} Max. | 0.5, 4.5 | - | 5 | 1.5 | | | | - | - | 1.5 | V |
| | 1.9 | - | 10 | 3 | | | | - | - | 3 | |
| | 1.5, 13.5 | - | 15 | 4 | | | | - | - | 4 | |
| Input High Voltage, V_{IH} Min. | 0.5, 4.5 | - | 5 | 3.5 | | | | 3.5 | - | - | V |
| | 1.9 | - | 10 | 7 | | | | 7 | - | - | |
| | 1.5, 13.5 | - | 15 | 11 | | | | 11 | - | - | |
| Input Current I_{IN} Max. | - | 0.18 | 18 | ± 0.1 | ± 0.1 | ± 1 | ± 1 | - | $\pm 10^{-5}$ | ± 0.1 | μA |

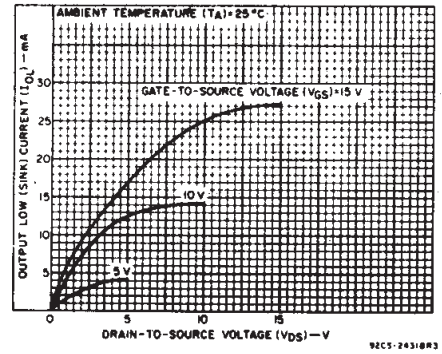


Fig. 5— Typical output low (sink) current characteristics.

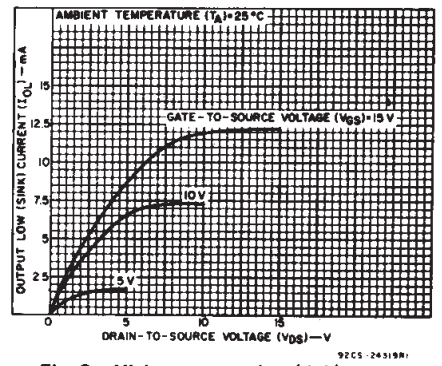


Fig. 6— Minimum output low (sink) current characteristics.

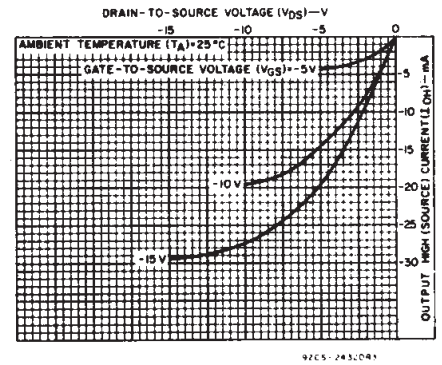


Fig. 7— Typical output high (source) current characteristics.

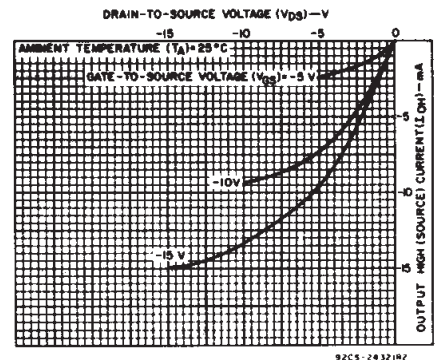


Fig. 8— Minimum output high (source) current characteristics.

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COMMERCIAL CMOS
HIGH VOLTAGE ICs

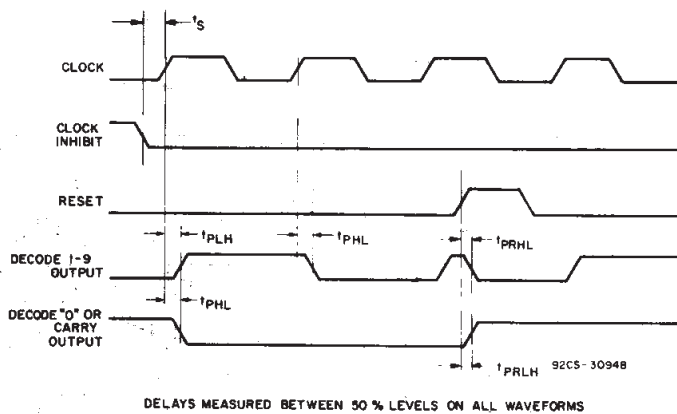
CD4017B, CD4022B Types

DYNAMIC ELECTRICAL CHARACTERISTICS

At $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$

| CHARACTERISTIC | CONDITIONS V_{DD} (V) | LIMITS | | | UNITS |
|---|----------------------------|-----------|------|------|-------|
| | | Min. | Typ. | Max. | |
| CLOCKED OPERATION | | | | | |
| Propagation Delay Time, t_{PHL}, t_{PLH} Decode Out | 5 | — | 325 | 650 | ns |
| | 10 | — | 135 | 270 | |
| | 15 | — | 85 | 170 | |
| Carry Out | 5 | — | 300 | 600 | ns |
| | 10 | — | 125 | 250 | |
| | 15 | — | 80 | 160 | |
| Transition Time, t_{THL}, t_{TLH} Carry Out or Decode Out Line | 5 | — | 100 | 200 | ns |
| | 10 | — | 50 | 100 | |
| | 15 | — | 40 | 80 | |
| Maximum Clock Input Frequency, f_{CL}^* | 5 | 2.5 | 5 | — | MHz |
| | 10 | 5 | 10 | — | |
| | 15 | 5.5 | 11 | — | |
| Minimum Clock Pulse Width, t_W | 5 | — | 100 | 200 | ns |
| | 10 | — | 45 | 90 | |
| | 15 | — | 30 | 60 | |
| Clock Rise or Fall Time, t_r, t_f | 5, 10, 15 | UNLIMITED | | | |
| Minimum Clock Inhibit to Clock Setup Time, t_s | 5 | — | 115 | 230 | ns |
| | 10 | — | 50 | 100 | |
| | 15 | — | 35 | 70 | |
| Input Capacitance, C_{IN} | Any Input | — | 5 | — | pF |
| RESET OPERATION | | | | | |
| Propagation Delay Time, t_{PHL}, t_{PLH} Carry Out or Decode Out Lines | 5 | — | 265 | 530 | ns |
| | 10 | — | 115 | 230 | |
| | 15 | — | 85 | 170 | |
| Minimum Reset Pulse Width, t_W | 5 | — | 130 | 260 | ns |
| | 10 | — | 55 | 110 | |
| | 15 | — | 30 | 60 | |
| Minimum Reset Removal Time | 5 | — | 200 | 400 | ns |
| | 10 | — | 140 | 280 | |
| | 15 | — | 75 | 150 | |

* Measured with respect to carry output line.



DELAYS MEASURED BETWEEN 50% LEVELS ON ALL WAVEFORMS

Fig. 9 - Propagation delay, setup, and reset removal time waveforms.

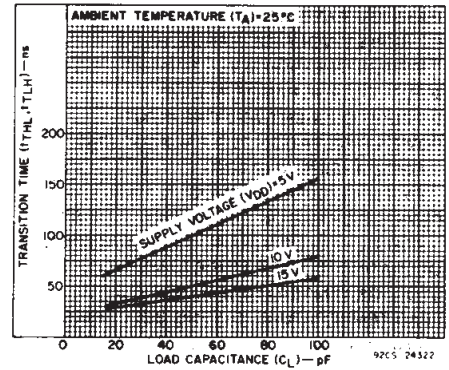


Fig. 10 - Typical transition time as a function of load capacitance.

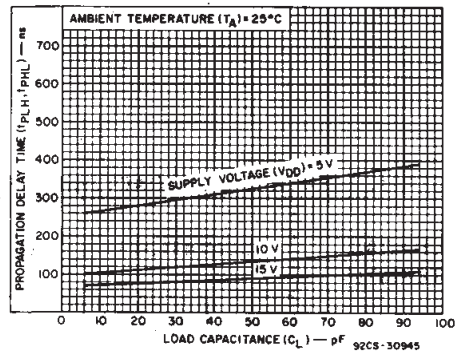


Fig. 11 - Typical propagation delay time as a function of load capacitance (clock to decode output).

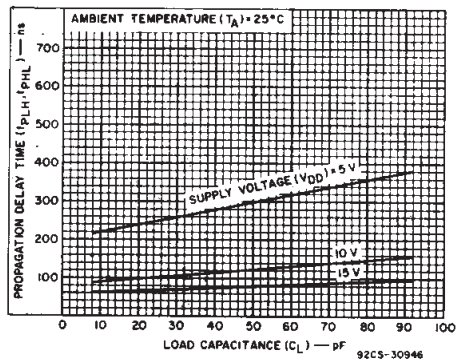


Fig. 12 - Typical propagation delay time as a function of load capacitance (clock to carry-out).

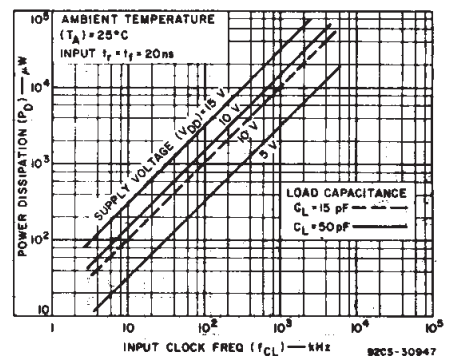


Fig. 13 - Typical dynamic power dissipation as a function of clock input frequency.

CD4017B, CD4022B Types

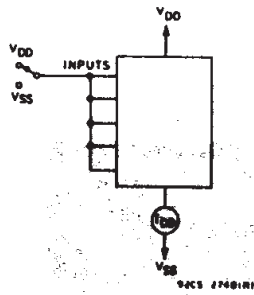


Fig. 14 - Quiescent device-current test circuit.

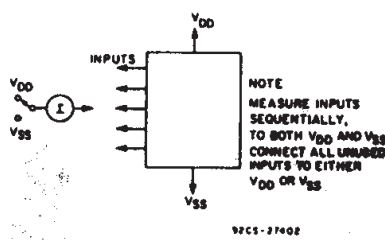


Fig. 15 - Input-leakage current.

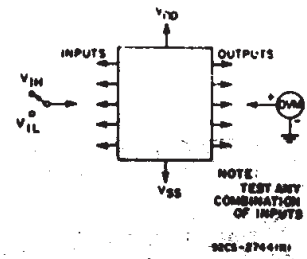


Fig. 16 - Input-voltage test circuit.

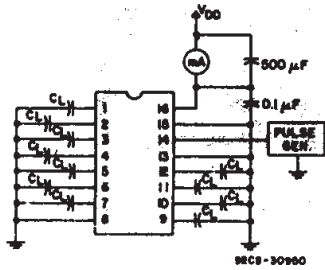


Fig. 17 - Dynamic power dissipation test circuit.

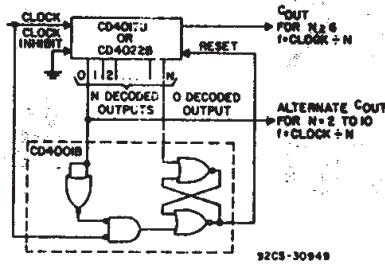


Fig. 18 - Divide by N counter ($N \leq 10$) with N decoded outputs.

When the N^{th} decoded output is reached (N^{th} clock pulse) the S-R flip flop (constructed from two NOR gates of the CD4001B) generates a reset pulse which clears the CD4017B or CD4022B to its zero count. At this time, if the N^{th} decoded output is greater than or equal to 6 in the CD4017B or 5 in the CD4022B; the C_{OUT} line goes high to clock the next CD4017B or CD4022B counter section. The "0" decoded output also goes high at this time. Coincidence of the clock low and decoded "0" output low resets the S-R flip flop to enable the CD4017B or CD4022B. If the N^{th} decoded output is less than 6 (CD4017B) or 5 (CD4022B), the C_{OUT} line will not go high and, therefore, cannot be used. In this case "0" decoded output may be used to perform the clocking function for the next counter.

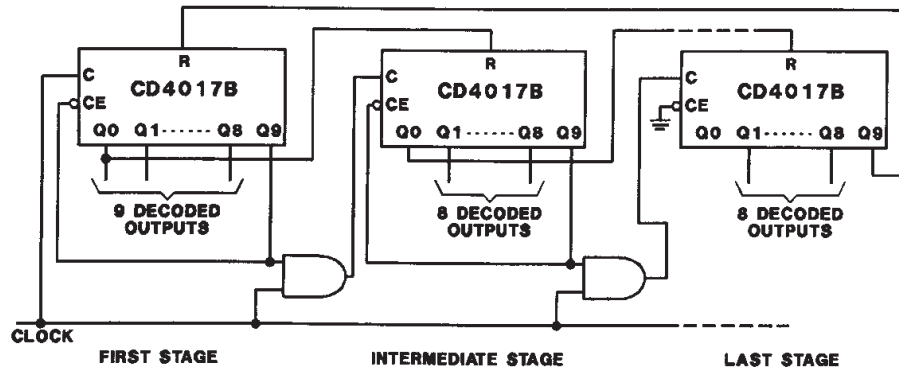
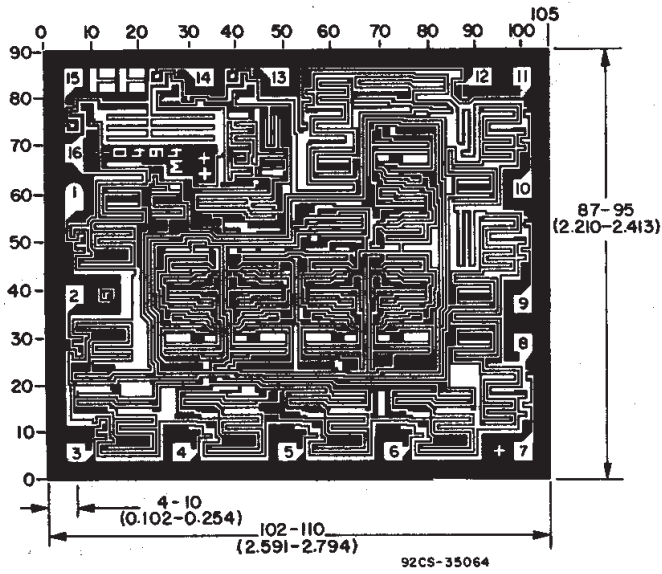


Fig. 19 - Cascading the CD4017B.

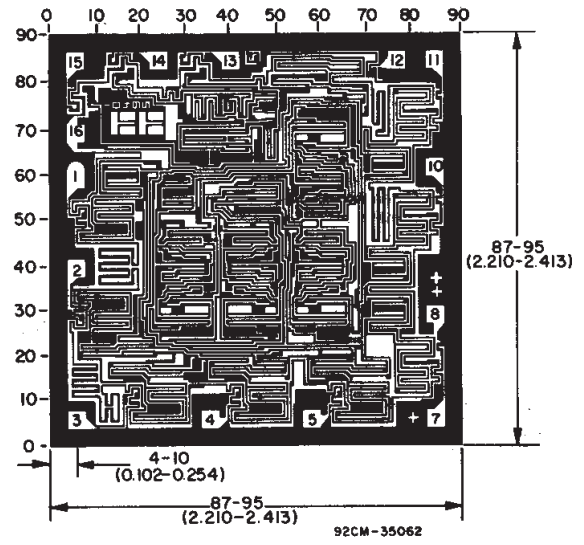
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COMMERCIAL CMOS
HIGH VOLTAGE ICs

CD4017B, CD4022B Types

CHIP DIMENSIONS AND PAD LAYOUTS



CD4017BH



CD4022BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

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